

#### **Features**

- High Dense Cell Design For Extremely Low R<sub>DS(ON)</sub>
- Rugged and reliable
- · High Speed Switching
- Epoxy Meets UL 94 V-0 Flammability Rating
- · Moisture Sensitivity Level 1
- Halogen Free. "Green" Device (Note 1)
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

### **Maximum Ratings**

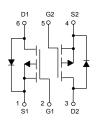
- Operating Junction Temperature Range : -55°C to +150°C
- Storage Temperature Range: -55°C to +150°C
- Maximum Thermal Resistance: 89°C/W Junction to Ambient<sup>(Note 2)</sup>

Parameter	Symbol	Rating	Unit
Drain -source Voltage	V <sub>DS</sub>	-20	V
Gate -Source Voltage	$V_{GS}$	±10	V
Drain Current-Continuous	I <sub>D</sub>	-3.8	Α
Drain Current-Pulse(Note 2)	I <sub>DM</sub>	-13	А
Power Dissipation	P <sub>D</sub>	1.4	W

#### Note:

1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

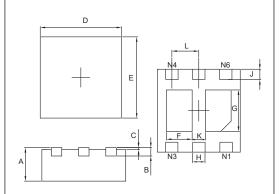
## **Internal Structure and Marking Code**





# **P-Channel MOSFET**

### DFN2020-6L



	DIMENSIONS				
DIM INCHES		MM		NOTE	
DIIVI	MIN	MAX	MIN	MAX	NOTE
Α	0.030	0.034	0.750	0.850	
В	0.0	0.008		200	TYP.
С	0.000	0.002	0.000	0.050	
D	0.077	0.081	1.950	2.050	
E	0.077	0.081	1.950	2.050	
F	0.017	0.027	0.440	0.690	
G	0.033	0.043	0.840	1.090	
Н	0.010	0.014	0.250	0.350	
J	0.007	0.015	0.175	0.375	
K	0.010	0.014	0.250	0.350	
L	0.026		0.650		TYP.



### **ELECTRICAL CHARACTERISTICS (Ta=25℃ unless otherwise specified)**

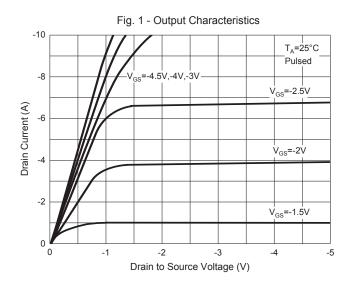
Parameter	Symbol	Test conditions	Min	Тур	Max	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =-250μA	-20			V
Gate-Threshold Voltage <sup>(Note 4)</sup>	$V_{GS(th)}$	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =-250μA	-0.5	-0.7	-0.9	V
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±8V, V <sub>DS</sub> =0V			±100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =-20V, V <sub>GS</sub> =0V			-1	μA
Drain-Source On-Resistance <sup>(Note 4)</sup>	D	V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-1.9A		49	70	mΩ
	R <sub>DS(on)</sub>	V <sub>GS</sub> =-2.5V, I <sub>D</sub> =-1.9A		59	90	- 11122
Forward Tranconductance <sup>(Note 4)</sup>	<b>g</b> FS	V <sub>DS</sub> =-5V, I <sub>D</sub> =-2.8A		8		S
Diode Forward Current (Note 3)	Is				-0.75	S
Diode Forward Voltage	V <sub>SD</sub>	V <sub>GS</sub> =0V, I <sub>S</sub> =-0.75A			-1.2	V
Dynamic Characteristics(Note 5)						
Input Capacitance	C <sub>iss</sub>			880		
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> =-6V,V <sub>GS</sub> =0V, f=1MHz		270		pF
Reverse Transfer Capacitance	C <sub>rss</sub>			175		
Switching Characteristics <sup>(Note</sup>	5)					
Turn-On Delay Time	t <sub>d(on)</sub>			11	20	
Turn-On Rise Time	t <sub>r</sub>	V <sub>DD</sub> =-6V,V <sub>GS</sub> =-4.5V,		5	10	
Turn-Off Delay Time	$t_{d(off)}$	$I_D$ =-1A,R <sub>GEN</sub> =6 $\Omega$		32	65	ns
Turn-Off Fall Time	t <sub>f</sub>			23	45	
Total Gate Charge	$Q_g$			11	14.5	
Gate-Source Chage	Q <sub>gs</sub>	V <sub>DS</sub> =-6V,V <sub>GS</sub> =-4.5V,I <sub>D</sub> =-2.8A		1.5		nC
Gage-Drain Charge	$Q_{gd}$			2.1		

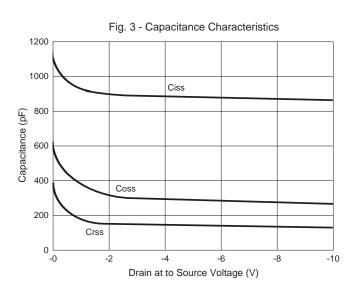
### Note:

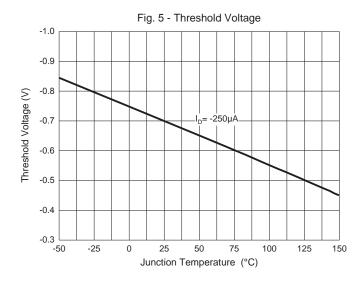
- 2. Surface Mounted on FR4 Board,t<5 sec.
- 3. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 4. Pulse Test: Pulse Width≤300µs,Duty Cycle≤2%.
- 5. Guaranteed by Design, Not Subject to Production Testing.

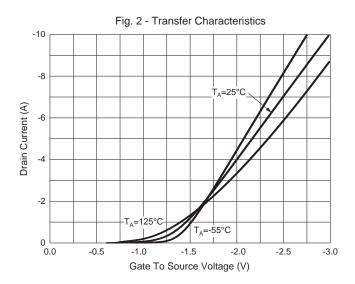


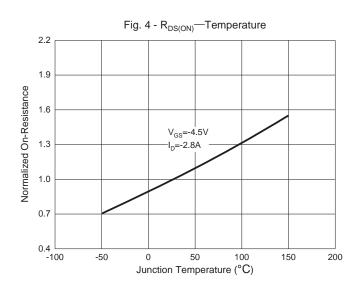
### **Curve Characteristics**

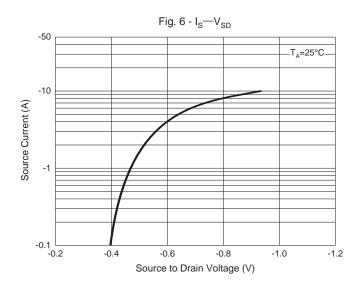














#### **Ordering Information**

Device	Packing	
Part Number-TP	Tape&Reel:3Kpcs/Reel	

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